

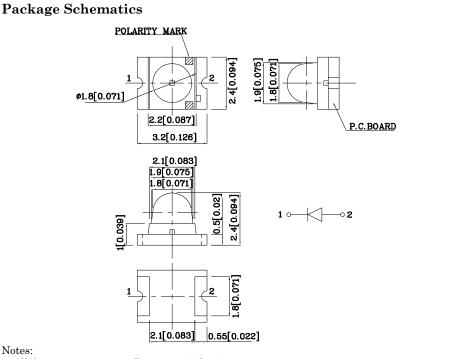
Part Number: XZM2ACR78W

3.2x2.4mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 1500pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant





1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.

3. Specifications are subject to change without notice.

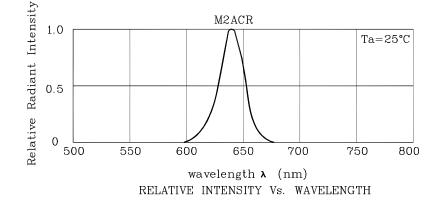
Absolute Maximum Ratings (T _A =25°C)		M2ACR (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	\mathbf{I}_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	PD	84	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	$-40 \sim +85$	-0	

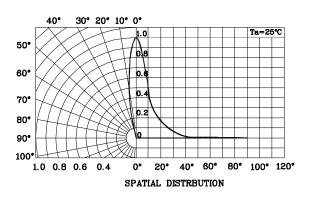
Operating Characteristics (T _A =25°C)		M2ACR (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.2	V	
Forward Voltage (Max.) (I _F =20mA)	$V_{\rm F}$	2.8	V	
Reverse Current (Max.) (V _R =5V)	I_{R}	10	uA	
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λΡ	640	nm	
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	625	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	25	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	27	$_{\rm pF}$	

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZM2ACR78W	Red	AlGaInP	Water Clear	7000	8990	640	20°

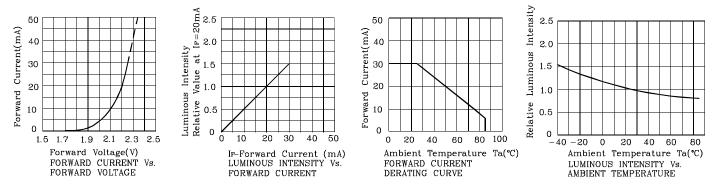
XDSB2780 V2 Layout: Maggie L.







♦ M2ACR



LED is recommended for reflow soldering and soldering profile is shown below.

300 (°C) 10 s max 250 4°C/s C/s max 200 150~ -180 4°C/s max 150 Temperature 30~50s 80~120: 100 50 0 150 0 50 100 200 250 300 (sec) Time Notes: 1. Maximum soldering temperature should not exceed 260°C

Reflow Soldering Profile for SMD Products (Pb-Free Components)

2. Recommended reflow temperature: 145°C-260°C

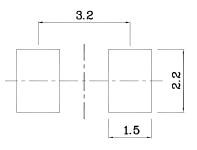
3. Do not put stress to the epoxy resin during

high temperatures conditions

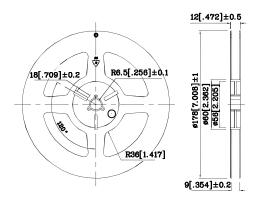


✤ The device has a single mounting surface. The device must be mounted according to the specifications.

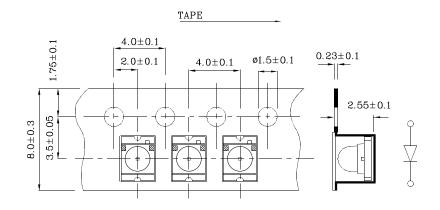
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15\%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Apr 02,2011



PACKING & LABEL SPECIFICATIONS

